

# 35V, 2.8A, ½-H control H-Bridge Motor Driver in a TSSOP-16 EP Package

#### DESCRIPTION

The MP6516 is an H-bridge motor driver that operates from a supply voltage up to 35V and delivers a motor current up to 2.8A. Typically, the MP6516 is used to drive a DC brush motor. For the MP6516, control of each half-bridge is independent, using IN1, IEN1, IN2, and EN2 pins.

An internal current-sensing circuit provides an output voltage proportional to the load current. The MP6516 also has cycle-by-cycle current regulation and limiting. These features do not require the use of a low-ohm shunt resistor.

Full protection features include over-current protection (OCP), input over-voltage protection (OVP), under-voltage lockout (UVLO), and thermal shutdown.

The MP6516 is available in a 16-pin TSSOP-EP (5.0mmx6.4mm) with an exposed thermal pad.

#### **FEATURES**

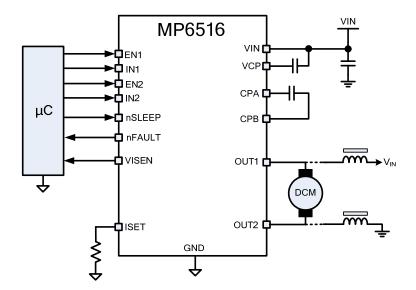
- Wide 5.4V to 35V Input Voltage Range
- 2.8A Peak Output Current
- ½-H control, input logic (INx, ENx)
- Internal Full H-Bridge Driver
- Cycle-by-cycle Current Regulation / Limit
- Low On Resistance (HS:250mΩ, LS:250mΩ)
- Simple, Versatile Logic Interfaces
- 3.3V and 5V Compatible Logic Supply
- Over-Current Protection (OCP)
- Over-Voltage Protection (OVP)
- Thermal Shutdown
- Under-Voltage Lockout (UVLO)
- Fault Indication Output
- Available in a Thermally Enhanced Surface-Mounted TSSOP-16 EP Package

## **APPLICATIONS**

- Solenoid Drivers
- DC Brush Motor Drivers

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## TYPICAL APPLICATION





## ORDERING INFORMATION

Part Number*	Package	Top Marking
MP6516GF	TSSOP-16 EP	See Below

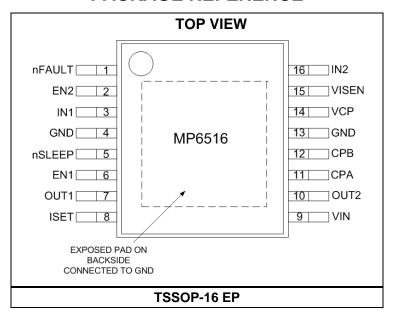
<sup>\*</sup> For Tape & Reel, add suffix –Z (e.g. MP6516GF–Z)

## **TOP MARKING**

MPSYYWW MP6516 LLLLLL

MPS: MPS prefix YY: Year code WW: Week code MP6516: Part number LLLLL: Lot number

## **PACKAGE REFERENCE**





ABSOLUTE MAXIMUM RATINGS (1)
Supply voltage (VIN)0.3V to 40V
OUTX voltage (V <sub>OUT1/2</sub> )0.7V to 40V
VCP, CPB $V_{IN}$ to $V_{IN}$ + 6.5V
ESD rating (HBD)2kV
ISET0.3V to 4.5V
All other pins to GND0.3V to 6.5V
Continuous power dissipation $(T_A = +25^{\circ}C)^{(2)}$
2.77W
Storage temperature55°C to +150°C
Junction temperature+150°C
Lead temperature (solder) +260°C
Recommended Operating Conditions (3)
Supply voltage (VIN)5.4V to 35V
Continuous output current (I <sub>OUT</sub> ) ±1.5A
Load current (I <sub>VISEN</sub> ) ±2mA
Operating junction temp. $(T_J)$ 40°C to +125°C

Thermal Resistance (4)	$\boldsymbol{\mathcal{O}_{JA}}$	$\boldsymbol{\Theta}_{JC}$	
TSSOP-16 EP	45	10	. °C/W

#### NOTES:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature  $T_J$  (MAX), the junction-to-ambient thermal resistance  $\theta_{JA}$ , and the ambient temperature  $T_A$ . The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D$  (MAX) = ( $T_J$  (MAX)- $T_A$ )/ $\theta_{JA}$ . Exceeding the maximum allowable power dissipation produces an excessive die temperature, causing the regulator to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



## **ELECTRICAL CHARACTERISTICS**

 $V_{IN} = 24V$ ,  $T_A = +25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Supply						
Input supply voltage	$V_{IN}$		5.4	24	35	V
Quiescent current	I <sub>Q</sub>	V <sub>IN</sub> = 24V, nSLEEP = 1, no load current		1.6	2.2	mA
	ISLEEP	$V_{IN}$ = 24V, nSLEEP = 0			1	μA
Charge pump frequency	f <sub>CP</sub>			680		kHz
Internal MOSFETs						•
	R <sub>HS</sub>	$V_{IN} = 24V, I_{OUT} = 1A,$ $T_{J} = 25^{\circ}C$ $V_{IN} = 24V, I_{OUT} = 1A,$		0.25	0.3	Ω
Output on resistance	' 'HS	$T_{J} = 85^{\circ}C$		0.3		Ω
output on resistance	R <sub>LS</sub>	$V_{IN} = 24V, I_{OUT} = 1A,$ $T_{J} = 25^{\circ}C$		0.25	0.3	Ω
	LS	$V_{IN} = 24V, I_{OUT} = 1A,$ $T_{J} = 85^{\circ}C$		0.3		Ω
Body diode forward voltage	$V_{F}$	I <sub>OUT</sub> = 1.5A			1.1	V
Control Logic						
Input logic low threshold	$V_{IL}$				0.8	V
Input logic high threshold	$V_{IH}$		2			V
Logic input current	I <sub>IN(H)</sub>	V <sub>IH</sub> = 5V	-20		20	μA
	I <sub>IN(L)</sub>	V <sub>IL</sub> = 0.8V	-20		20	μA
T FD					kΩ	
nFault Output (Open-Drain Ou	<del>,</del>	Τ		1	_	
Output low voltage	V <sub>OL</sub>	$I_O = 5mA$			0.5	V
Output high leakage current	I <sub>OH</sub>	$V_0 = 3.3V$			1	μΑ
Protection Circuits	Г.,	T		1		
UVLO rising threshold	V <sub>IN RISE</sub>		4.7	5	5.3	V
UVLO hysteresis	V <sub>HYS</sub>			310		mV
Input OVP threshold	V <sub>OVP</sub>		36	38	40	V
Input OVP hysteresis	$\Delta V_{OVP}$			2000		mV
Over-current trip level	I <sub>OCP1</sub>	Sinking	3.2	4	5.3	Α
•	I <sub>OCP2</sub>	Sourcing	3.2	4	5.3	Α
Over-current deglitch time (5)	t <sub>OCPD</sub>			500		ns
Over-current retry time	t <sub>OCPR</sub>			0.9		ms
Thermal shutdown	T <sub>TSD</sub>			165		°C
Thermal shutdown hysteresis	$\Delta T_{TSD}$			30		°C
Current Control						
Off time	t <sub>ITRIP</sub>	After ITRIP		0.9		ms
ISET current	I <sub>ISET</sub>		90	100	110	μA/A
Current trip voltage	V <sub>ITRIP</sub>	At VISEN	1.44	1.5	1.56	V
VISEN Output						
Output voltage accuracy	$\Delta V_{VISEN}$	$V_{ISET} > 0.5V$	-5		5	%

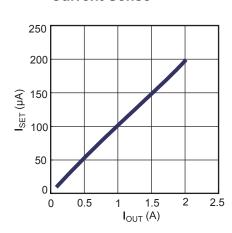
note:

5) Guaranteed by design.

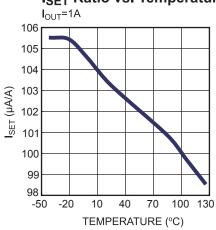


## **TYPICAL CHARACTERISTICS**

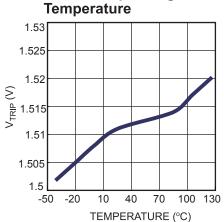
#### **Current Sense**



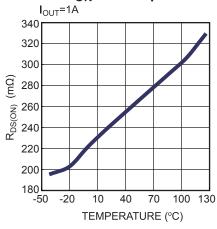
I<sub>SET</sub> Ratio vs. Temperature



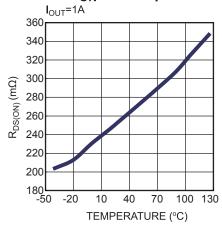
**Current Trip Voltage vs.** 



## **HS R<sub>ON</sub> vs. Temperature**



## LS R<sub>ON</sub> vs. Temperature





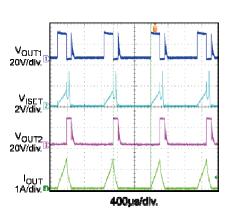
## TYPICAL PERFORMANCE CHARACTERISTICS

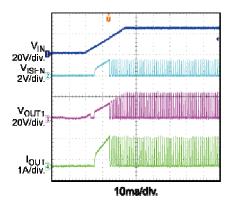
 $V_{IN}$  = 24V,  $I_{OUT}$  = 1A,  $T_A$  = 25°C, unless otherwise noted.

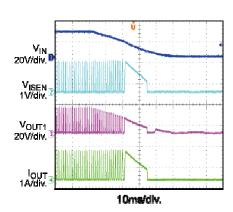
## **Steady State**



Input Power Shutdown







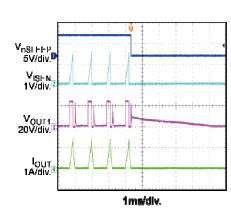
## Sleep Start-Up

V<sub>nSLEEP</sub>
5V/div.
V<sub>ISEN</sub>
1V/div.

V<sub>OUT1</sub>
20V/div.

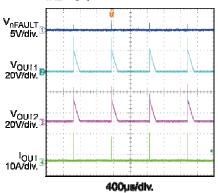
Ina/div.

## Sleep Shutdown

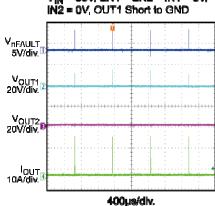


SCP

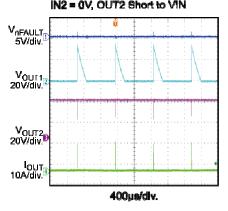
V<sub>IN</sub> = 35V, EN1 = EN2 = IN1 = 5V, IN2 = 0V, OUT1 Short to OUT2



SCP V<sub>IN</sub> = 35V, EN1 = EN2 = IN1 = 5V, IN2 = 0V, OUT1 Short to GND



SCP V<sub>IN</sub> = 35V, EN1 = EN2 = IN1 = 5V, IN2 = 0V, OUT2 Short to VIN



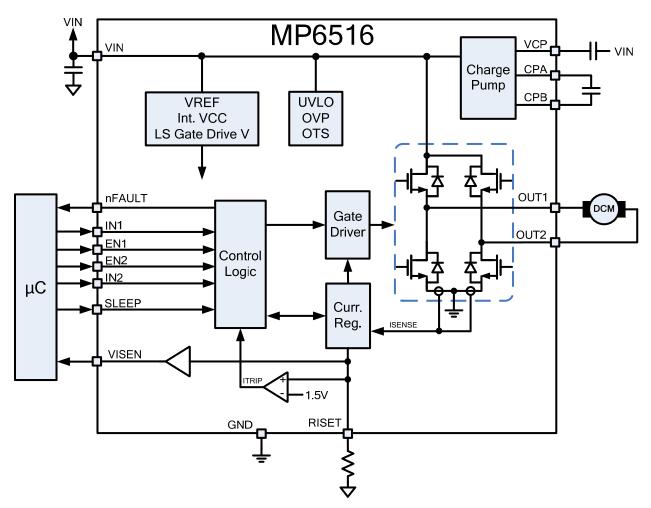


## **PIN FUNCTIONS**

Pin #	Name	Description
1	nFAULT	<b>Fault indication.</b> nFAULT is an open-drain output type. nFAULT is logic low when in a fault condition (i.e.: OCP, OTP, OVP).
2	EN2	Output 2 enable input. Drive EN2 high to enable OUT2. EN2 is pulled down internally.
3	IN1	Output 1 control input. IN1 is pulled down internally.
4, 13	GND	System ground connection.
5	nSLEEP	<b>Sleep mode input.</b> Drive nSLEEP to logic low to enter low-power sleep mode. nSLEEP is pulled down internally.
6	EN1	Output 1 enable input. Drive EN1 high to enable OUT1. EN1 is pulled down internally.
7	OUT1	Output terminal 1.
8	ISET	<b>Current programming resistor.</b> Connect a resistor to ground to set the current limit and VISEN output voltage.
9	VIN	<b>Input supply voltage.</b> Decouple VIN to GND with a minimum 100nF ceramic capacitor to GND.
10	OUT2	Output terminal 2.
11	CPA	Charge pump flying capacitor. Connect a 100nF ceramic capacitor between CPA
12	CPB	and CPB.
14	VCP	Charge pump output. Connect a 1µF capacitor to VIN.
15	VISEN	Current sense output voltage.
16	IN2	Output 2 control input. IN2 is pulled down internally.
EP	GND	Exposed pad. The exposed pad must be connected to ground.



## **BLOCK DIAGRAM**



**Figure 1: Functional Block Diagram** 

#### **OPERATION**

The MP6516 is an H-bridge motor driver that integrates four N-channel power MOSFETs with 2.8A of peak current capability. The MP6516 operates over a wide 5.4V to 35V input voltage range and is designed to drive bipolar stepper motors, DC brush motors, solenoids, or other loads.

## **Current Sensing**

The current flowing into the two low-side MOSFETs (LS-FET) is sensed with an internal current sensing circuit. A voltage proportional to the output currents is sourced on VISEN.

VISEN output voltage scaling is set by a resistor connected between ISET and ground. For 1A of output current, 100 $\mu$ A of current is sourced into the resistor connected to ISET. For example, if a 10k $\Omega$  resistor is connected between ISET and ground, the output voltage on VISEN is 1V/A of output current. Current is sensed when one of the LS-FETs is turned on. The load current applied to VISEN should be kept below 2mA with no more than 500pF of capacitance.

#### **Current Limit and Regulation**

The current in the outputs is limited using constant-off-time pulse-width modulation (PWM) control circuitry. Initially, a diagonal pair of MOSFETs turns on and drives current through the load. The current increases in the load, which is sensed by the internal current-sense circuit. If the load current reaches the current trip threshold, the entire H-bridge switches to a high impedance with all MOSFETs turned off. After a fixed off-time ( $t_{ITRIP}$ ), the MOSFETs are re-enabled, and the cycle repeats.

Note that the current is sensed only in the LS-FETs. If the outputs are used to drive a load that is connected to ground directly, the current regulation and current measurement do not function.

The current limit threshold is reached when VISET reaches 1.5V. For example, with a  $10k\Omega$  resistor from ISET to ground, the VISET voltage is 1V/A of the output current. Therefore, when the current reaches 1.5A, the VISET voltage reaches 1.5V, and a current trip occurs.

## **Blanking Time**

There is often a current spike during turn-on due to the body diode's reverse-recovery current or the shunt capacitance of the load. This current spike requires filtering to prevent it from shutting down the high-side MOSFET (HSFET) erroneously. An internal, fixed, blanking time  $(t_{\text{OCPD}})$  blanks the output of the current sense comparator when the outputs are switched. This blanking time also sets the minimum on time for the HS-FET.

## **Input Logic**

For the MP6516, control of each half-bridge is independent, using IN1, IEN1, IN2, and EN2 (see Table 1).

**Table 1: Truth Table** 

ENx	INx	OUTx
0	0	Z
0	1	Z
1	0	L
1	1	Н

## **nSLEEP Operation**

Driving nSLEEP low puts the MP6516 into a low-power sleep state. In this state, all internal circuits including the gate drive charge pump are disabled, and the H-bridge outputs are turned off. All inputs are ignored when nSLEEP is active low. When waking up from sleep mode, approximately 1ms of time must pass before the outputs operate.

#### **Fault Indicator (nFAULT)**

The MP6516 provides an nFAULT pin that is driven active low if any of the protection circuits are activated. These fault conditions include over-current, over-temperature, and over-voltage. nFAULT is also driven low when a current-limit trip occurs. nFAULT is an open-drain output and requires an external pull-up resistor. When the fault condition is removed, nFAULT is pulled inactive high by the pull-up resistor.

## **Over-Current Protection (OCP)**

The over-current protection (OCP) circuit limits the current through each MOSFET by reducing the gate drive voltage to the MOSFET. If the MOSFET remains in the current-limit condition for longer than the over-current deglitch time, all MOSFETs in the H-bridge are disabled, and nFAULT is driven low. The driver remains disabled for t<sub>OCP</sub> and is re-enabled automatically. Over-current conditions are sensed on both high- and low-side devices. A short to ground, supply, or across the motor winding results in an over-current shutdown. Note that OCP does not use the current sense circuitry used for the PWM current control and is independent of the ISET resistor value.

## **Over-Voltage Protection (OVP)**

If the input voltage applied to VIN is higher than the OVP threshold, the H-bridge output is disabled, and nFAULT is driven low. This protection is released when VIN drops to a safe level.

## Input Under-Voltage Lockout (UVLO)

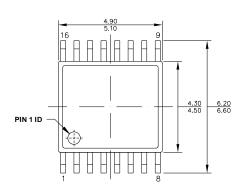
If the voltage on VIN falls below the undervoltage lockout (UVLO) threshold at any time, all circuitry in the device is disabled, and the internal logic is reset. Operation resumes when VIN rises above the UVLO threshold.

#### Thermal Shutdown

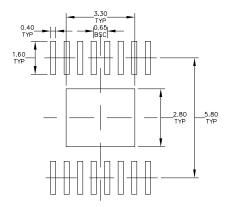
If the die temperature exceeds safe limits, all MOSFETs in the H-bridge are disabled, and nFAULT is driven low. Once the die temperature has fallen to a safe level, operation resumes automatically.

## **PACKAGE INFORMATION**

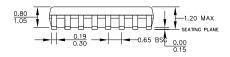
## **TSSOP-16 EP (5.0mmx6.4mm)**



**TOP VIEW** 



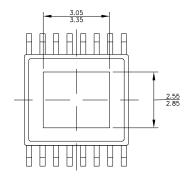
**RECOMMENDED LAND PATTERN** 



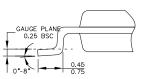
**FRONT VIEW** 



**SIDE VIEW** 



**BOTTOM VIEW** 



**DETAIL "A"** 

## NOTE:

1) ALL DIMENSIONS ARE IN MILLIMETERS
2) PACKAGE LENGTH DOES NOT INCLUDE MOLD
FLASH, PROTRUSION OR GATE BURR.
3) PACKAGE WITCH DOES NOT INCLUDE INTERLEAD
FLASH OR PROTRUSION.
4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER
FORMING) SHALL BE 0.10 MILLIMETERS MAX
5) DRAWING CONFORMS TO JEDEC MO-153,
VARIATION ABT.
6) DRAWING IS NOT TO SCALE

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